



# PNE200100EPE

200 V, 10 A hyperfast recovery rectifier

16 June 2022

Product data sheet

## 1. General description

High power density, hyperfast switching time recovery rectifier with high-efficiency planar technology, encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Reverse voltage:  $V_R \leq 200$  V
- Forward current:  $I_F \leq 10$  A
- Switching time:  $t_{tr} \leq 30$  ns
- Pt doped life time control
- Low inductance
- Power and flat lead SMD plastic package
- Package height typical 0.95 mm
- High power capability due to clip-bond technology
- Planar die design

## 3. Applications

- General-purpose rectification
- Reverse polarity protection
- Hyperfast switching
- Freewheeling applications
- Engine Control Unit (ECU)

## 4. Quick reference data

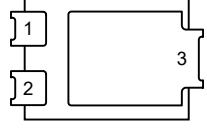
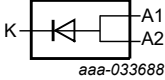
Table 1. Quick reference data

| Symbol      | Parameter                       | Conditions   |     | Min | Typ | Max | Unit    |
|-------------|---------------------------------|--|-----|-----|-----|-----|---------|
| $I_{F(AV)}$ | average forward current         | $\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 171$ °C |     | -   | -   | 10  | A       |
| $V_R$       | reverse voltage                 | $T_j = 25$ °C  |     | -   | -   | 200 | V       |
| $V_{RRM}$   | repetitive peak reverse voltage |  |     | -   | -   | 200 | V       |
| $V_F$       | forward voltage                 | $I_F = 10$ A; $T_j = 25$ °C                                      | [1] | -   | 890 | 960 | mV      |
|             |                                 | $I_F = 10$ A; $T_j = 125$ °C                                     | [1] | -   | 750 | 820 | mV      |
| $I_R$       | reverse current                 | $V_R = 200$ V; $T_j = 25$ °C                                     | [1] | -   | -   | 1   | $\mu$ A |
|             |                                 | $V_R = 200$ V; $T_j = 125$ °C                                    | [1] | -   | 3   | 25  | $\mu$ A |

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline   | Graphic symbol  |
|-----|--------|-------------|--|---|
| 1   | A1     | anode 1     | <br>CFP15B (SOT1289B) | <br>aaa-033688 |
| 2   | A2     | anode 2     |  |   |
| 3   | K      | cathode     |  |   |

## 6. Ordering information

Table 3. Ordering information

| Type number                  | Package |  |                          |
|------------------------------|---------|--|--------------------------|
|                              | Name    | Description  | Version                  |
| <a href="#">PNE200100EPE</a> | CFP15B  | plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body | <a href="#">SOT1289B</a> |

## 7. Marking

Table 4. Marking codes

| Type number  | Marking code |
|--------------|--------------|
| PNE200100EPE | 200E<br>110E |

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134)

| Symbol          | Parameter                           | Conditions  |     | Min | Max  | Unit |
|-----------------|-------------------------------------|---|-----|-----|------|------|
| $V_R$           | reverse voltage                     | $T_j = 25\text{ °C}$  |     | -   | 200  | V    |
| $V_{RRM}$       | repetitive peak reverse voltage     |   |     | -   | 200  | V    |
| $V_{R(RMS)lim}$ | limiting RMS reverse voltage        |   |     | -   | 140  | V    |
| $I_F$           | forward current                     | $\delta = 1; T_{sp} \leq 150\text{ °C}$   |     | -   | 14.1 | A    |
| $I_{F(AV)}$     | average forward current             | $\delta = 0.5; f = 20\text{ kHz}$ ; square wave; $T_{sp} \leq 171\text{ °C}$                                  |     | -   | 10   | A    |
| $I_{FSM}$       | non-repetitive peak forward current | $t_p = 8.3\text{ ms}$ ; single half sine wave (applied at rated load condition); $T_{j(init)} = 25\text{ °C}$ |     | -   | 190  | A    |
| $P_{tot}$       | total power dissipation             | $T_{amb} \leq 25\text{ °C}$   | [1] | -   | 1.75 | W    |
|                 |                                     |   | [2] | -   | 2.15 | W    |
| $T_j$           | junction temperature                |   |     | -   | 175  | °C   |
| $T_{amb}$       | ambient temperature                 |   |     | -55 | 175  | °C   |
| $T_{stg}$       | storage temperature                 |   |     | -65 | 175  | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter  | Conditions  |     | Min | Typ | Max | Unit |
|----------------|--|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1] | -   | -   | 85  | K/W  |
|                |  |             | [2] | -   | -   | 70  | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             | [3] | -   | -   | 1.2 | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Soldering point of cathode tab.

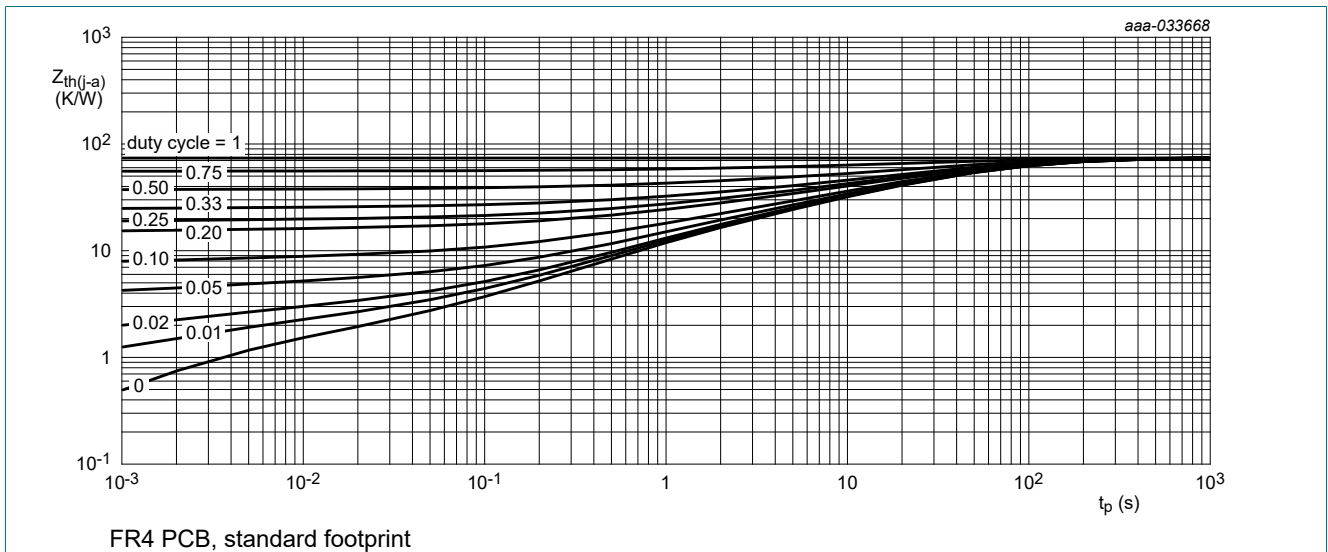


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

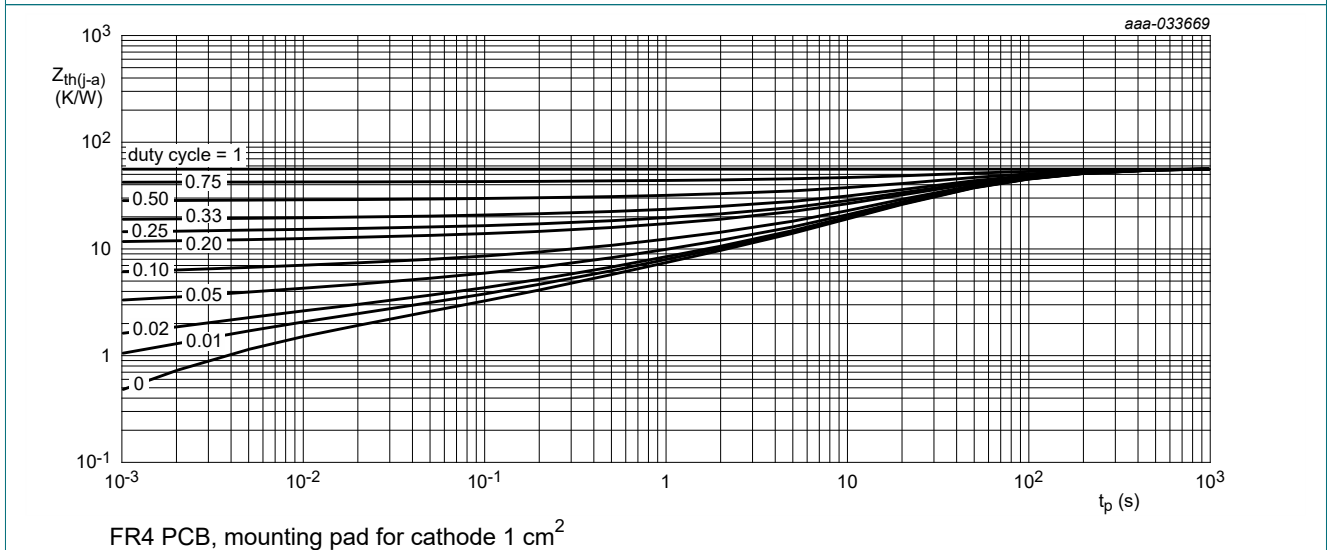


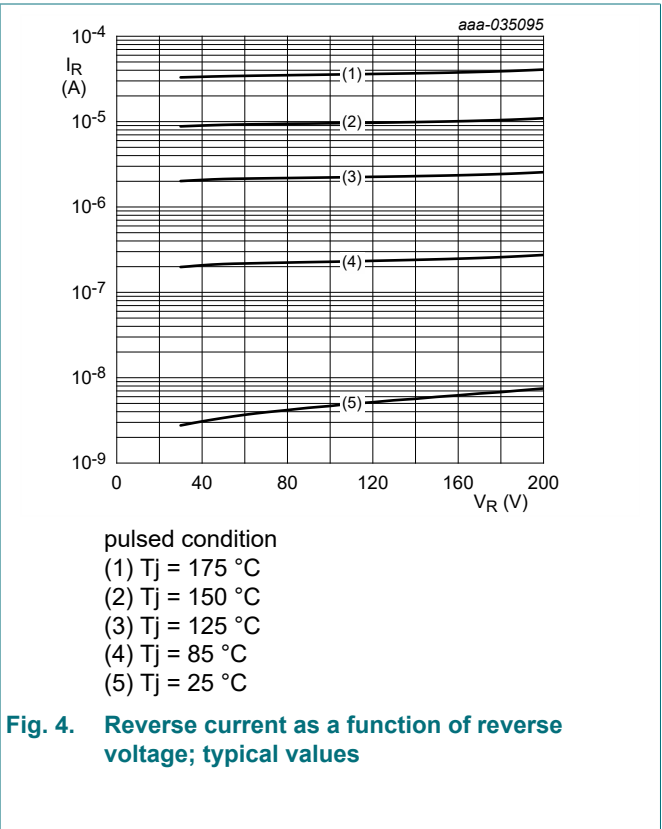
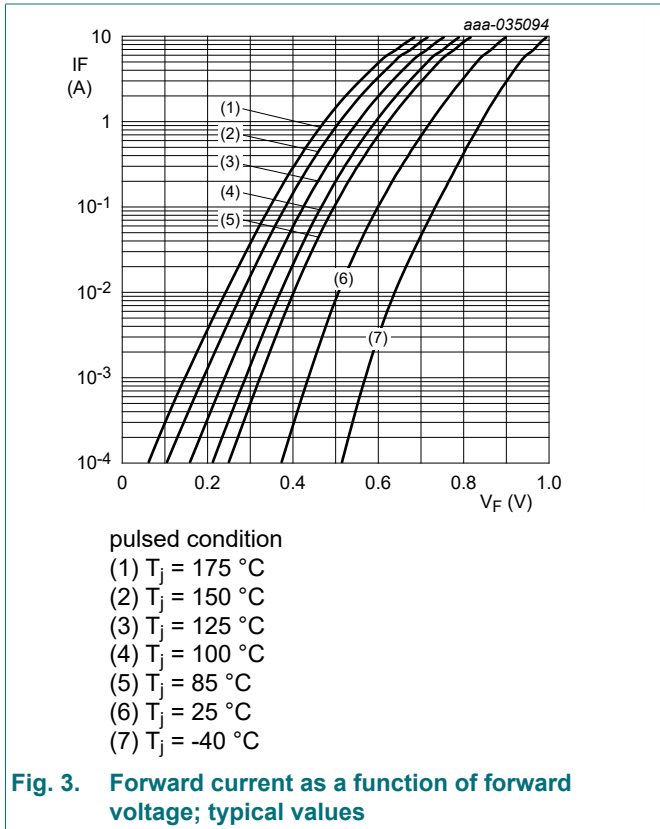
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

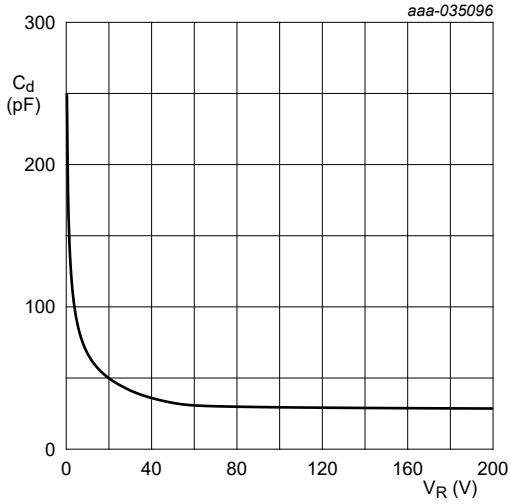
### 10. Characteristics

Table 7. Characteristics

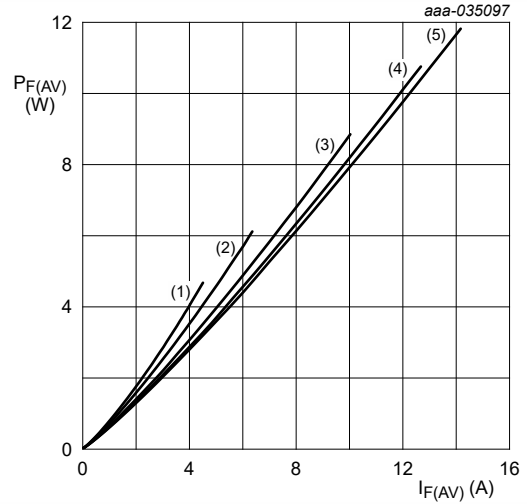
| Symbol      | Parameter                     | Conditions  | Min | Typ | Max | Unit |         |
|-------------|-------------------------------|---|-----|-----|-----|------|---------|
| $V_{(BR)R}$ | reverse breakdown voltage     | $I_R = 100 \mu A; T_j = 25 \text{ }^\circ C$                              | [1] | 200 | -   | V    |         |
| $V_F$       | forward voltage               | $I_F = 10 A; T_j = 25 \text{ }^\circ C$                                   | [1] | -   | 890 | 960  | mV      |
|             |                               | $I_F = 10 A; T_j = 125 \text{ }^\circ C$                                  | [1] | -   | 750 | 820  | mV      |
| $I_R$       | reverse current               | $V_R = 200 V; T_j = 25 \text{ }^\circ C$                                  | [1] | -   | -   | 1    | $\mu A$ |
|             |                               | $V_R = 200 V; T_j = 125 \text{ }^\circ C$                                 | [1] | -   | 3   | 25   | $\mu A$ |
| $C_d$       | diode capacitance             | $V_R = 4 V; f = 1 \text{ MHz}; T_j = 25 \text{ }^\circ C$                 | -   | 99  | -   | pF   |         |
| $t_{rr}$    | reverse recovery time         | $I_F = 0.5 A; I_R = 1 A; I_{R(meas)} = 0.25 A; T_j = 25 \text{ }^\circ C$ | -   | 16  | 30  | ns   |         |
|             | step recovery                 | $di_F/dt = 50 A/\mu s; I_F = 1 A; V_R = 30 V; T_j = 25 \text{ }^\circ C$  | -   | 21  | -   | ns   |         |
| $V_{FRM}$   | peak forward recovery voltage | $I_F = 1 A; di_F/dt = 50 A/\mu s; T_j = 25 \text{ }^\circ C$              | -   | 780 | -   | mV   |         |

[1] Very short pulse, in order to maintain a stable junction temperature.

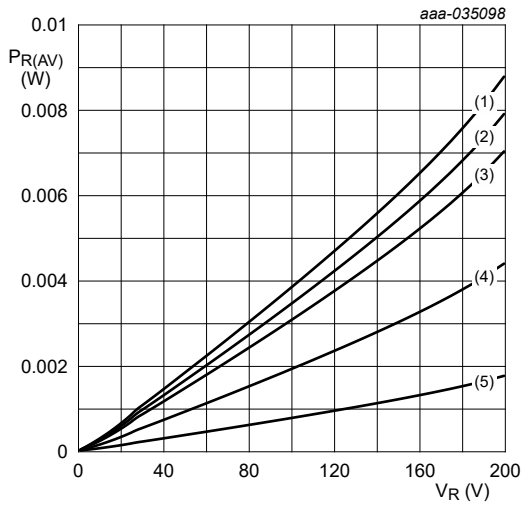




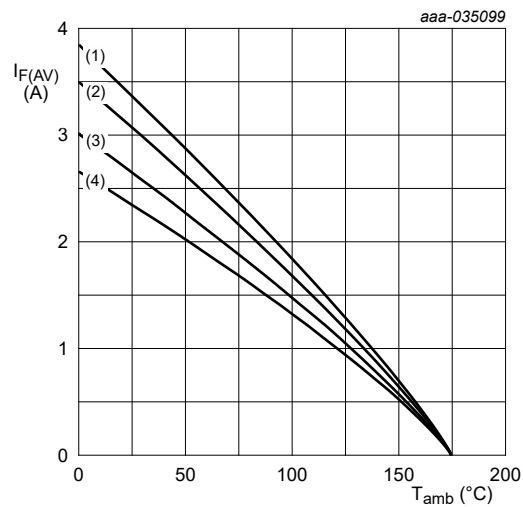
**Fig. 5. Diode capacitance as a function of reverse voltage; typical values**



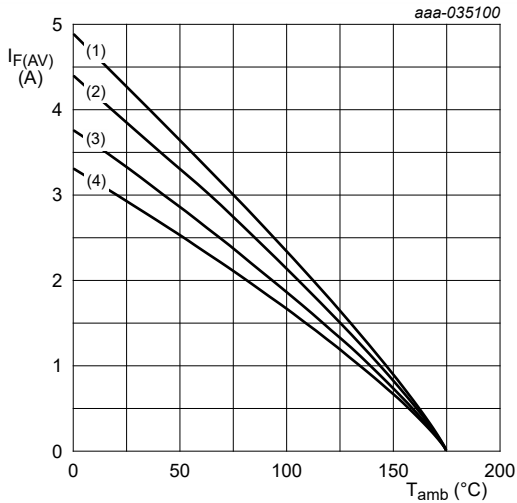
**Fig. 6. Average forward power dissipation as a function of average forward current; typical values**



**Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values**

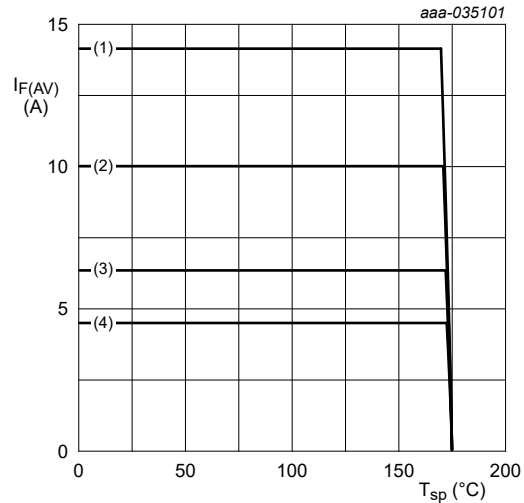


**Fig. 8. Average forward current as a function of ambient temperature; typical values**



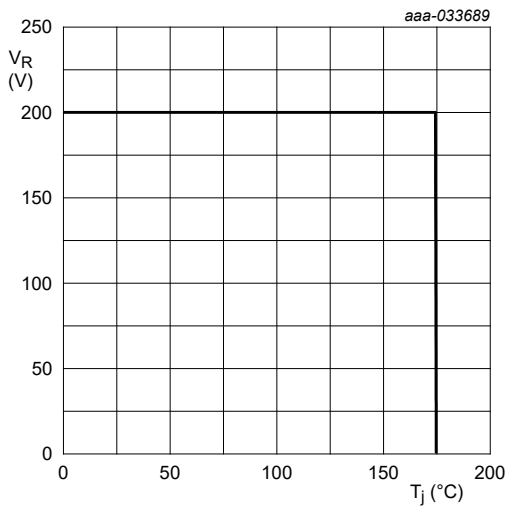
FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  
 $T_j = 175$  °C  
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20$  kHz  
 (3)  $\delta = 0.2$ ;  $f = 20$  kHz  
 (4)  $\delta = 0.1$ ;  $f = 20$  kHz

**Fig. 9. Average forward current as a function of ambient temperature; typical values**



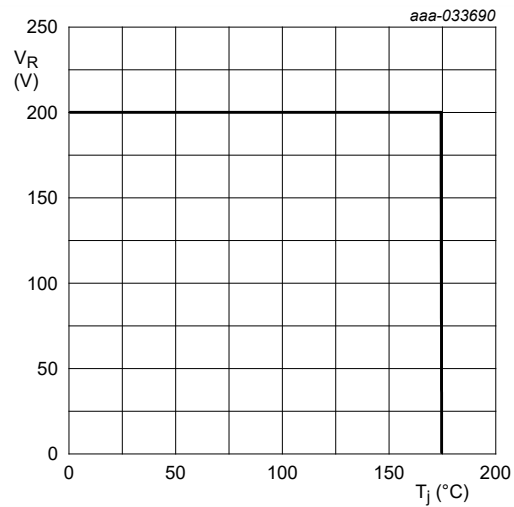
$T_j = 175$  °C  
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20$  kHz  
 (3)  $\delta = 0.2$ ;  $f = 20$  kHz  
 (4)  $\delta = 0.1$ ;  $f = 20$  kHz

**Fig. 10. Average forward current as a function of solder point temperature; typical values**



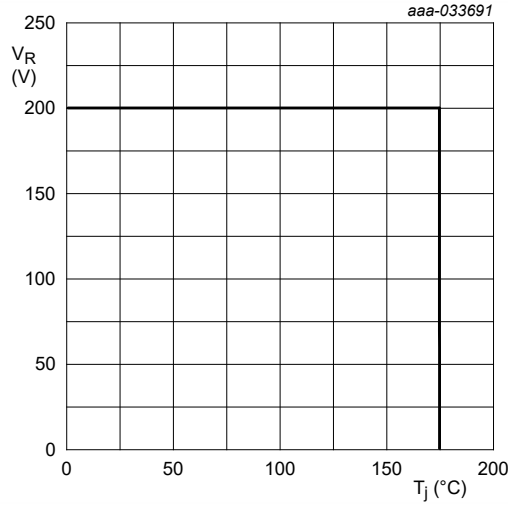
FR4 PCB, standard footprint  
 $R_{th} = 85$  K/W

**Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values**



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  
 $R_{th} = 70$  K/W

**Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values**



Soldering point of cathode tab  
 $R_{th} = 1.2 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

### 11. Test information

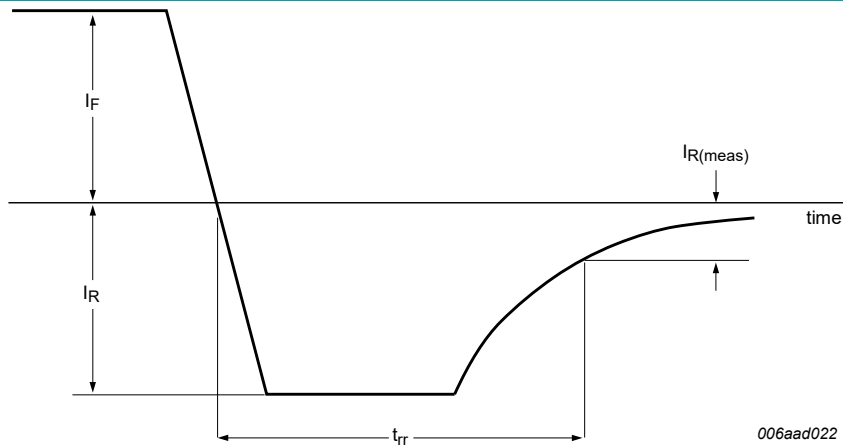


Fig. 14. Reverse recovery definition; step recovery

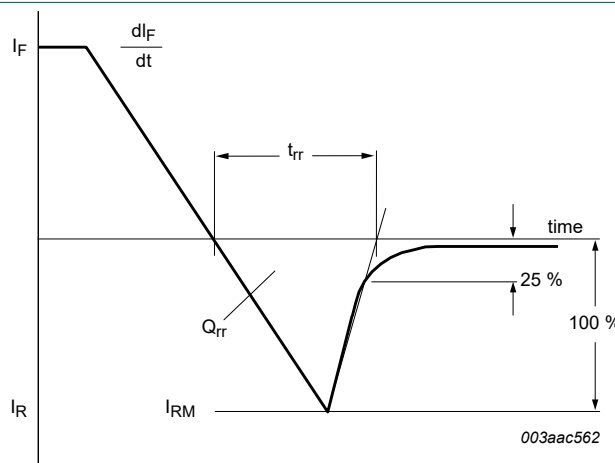


Fig. 15. Reverse recovery definition; ramp recovery

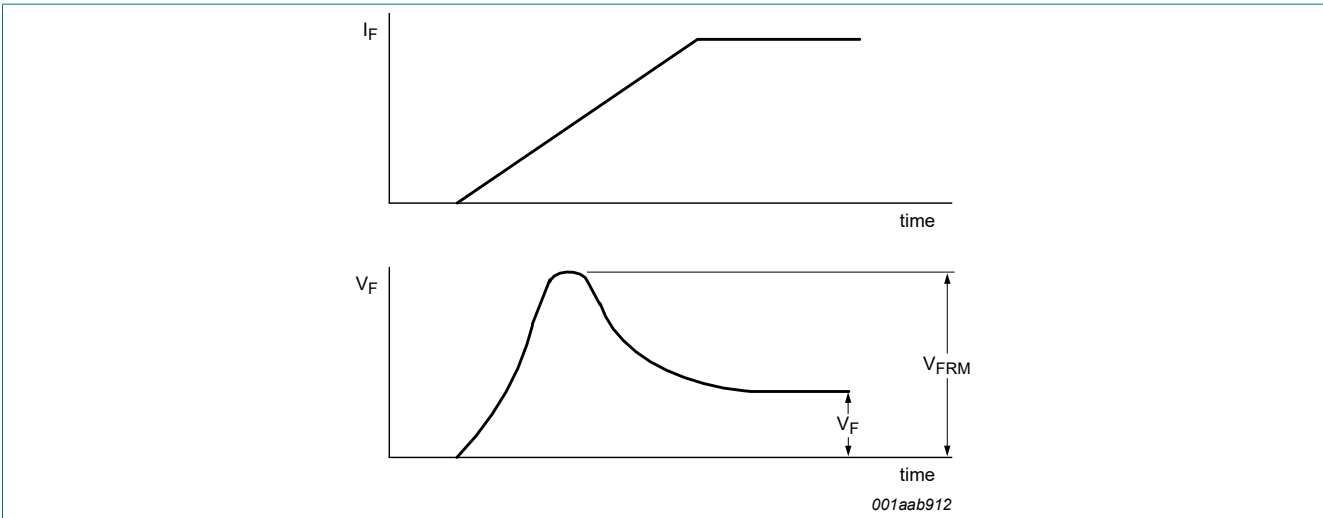


Fig. 16. Forward recovery definition

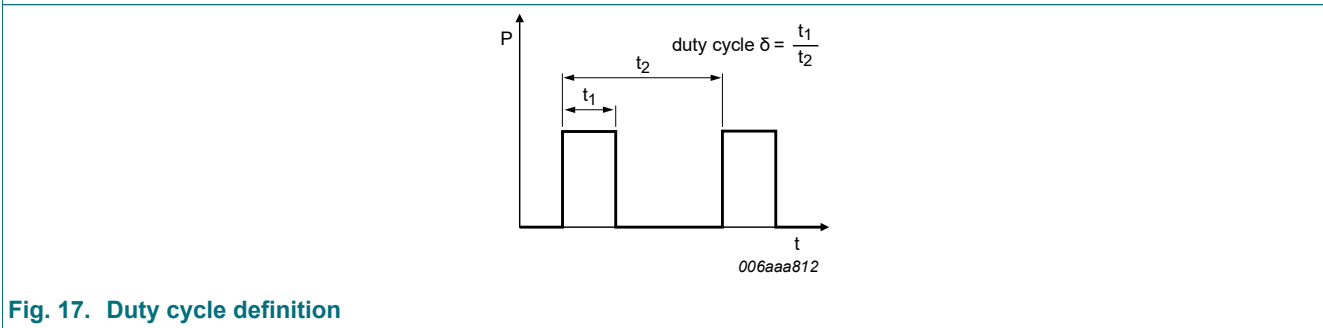


Fig. 17. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC, and } I_{RMS} = I_M \times \sqrt{\delta}$$

with  $I_{RMS}$  defined as RMS current.

## 12. Package outline

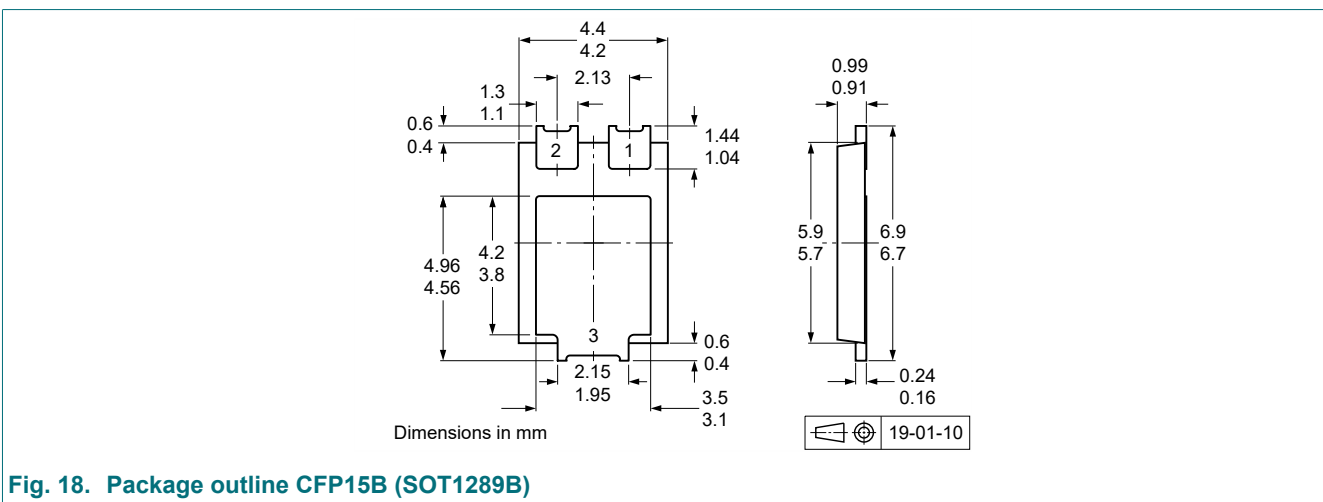
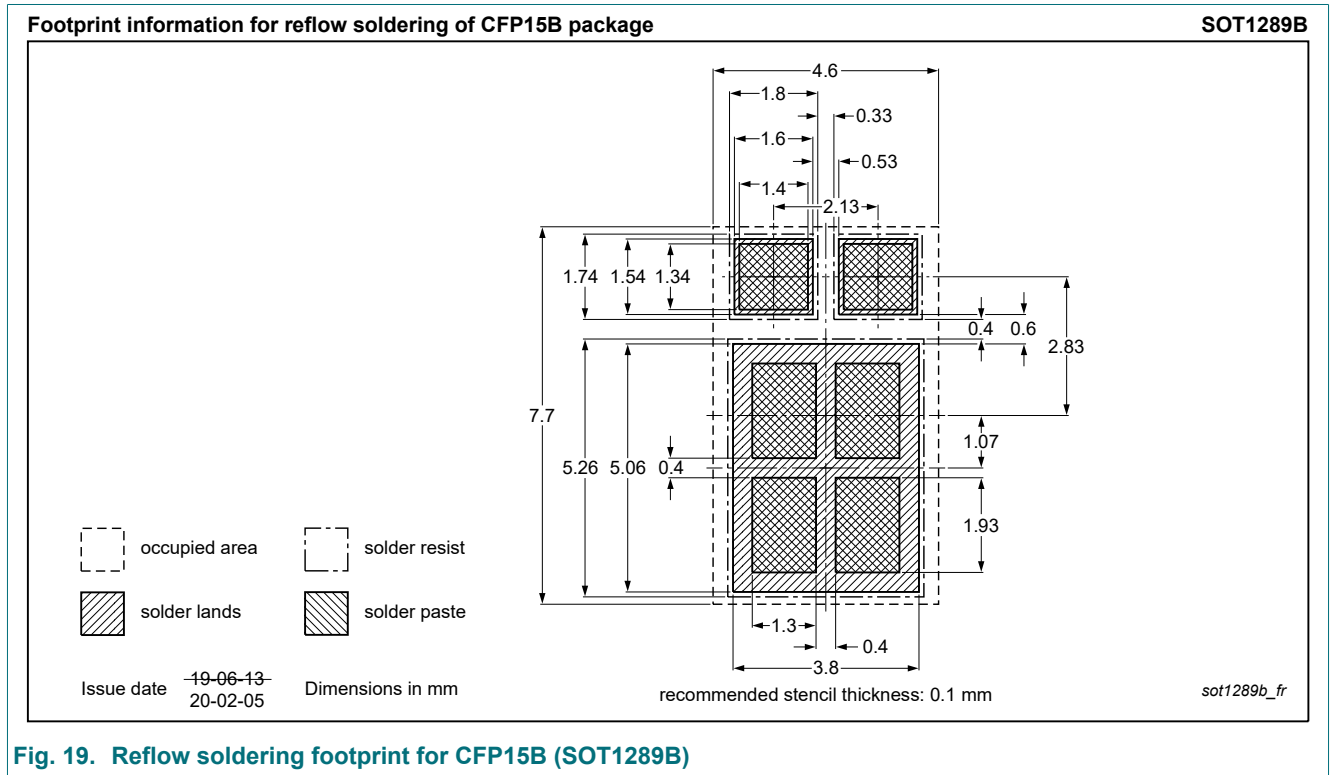


Fig. 18. Package outline CFP15B (SOT1289B)



### 13. Soldering



**Fig. 19. Reflow soldering footprint for CFP15B (SOT1289B)**

### 14. Revision history

Table 8. Revision history

| Data sheet ID    | Release date | Data sheet status  | Change notice | Supersedes |
|------------------|--------------|--------------------|---------------|------------|
| PNE200100EPE v.1 | 20220616     | Product data sheet | -             | -          |

## 15. Legal information

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| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
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| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
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